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Anventor: SUNETRA K. MENDIS, TZI-HSIUNG SHU

PIXEL DEFECT CORRECTION IN A CMOS ACTIVE PIXEL IMAGE SENSOR



Enclosed a	re:							
x 1 sheets of drawing(s) - formal.								
X An a	An assignment of the invention to Vanguard International Semiconductor Corporation							
An associate power of attorney Applicant claims small entity status								
X Requ	est & Cer	tificatio	n under 35 (JSC 122(b)(2)(b)(i)			
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NONPUBLICATION REQUEST UNDER 35 U.S.C. 122(b)(2)(B)(i)

First N	lamed Inventor	Mendis, S.K.
Title	Pixel Def	ect Correction In A tive Pixel Image Sensor
	ocket Number	V/15:A-570

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

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This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application upon filing.

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